PTO/SB/08A				Complete if Known		
				Application Number	10/597,374	
INFORMATION DISCLOSURE				Filing Date	07/21/2006	
STA	STATEMENT BY APPLICANT			First Named Inventor	Chen Xu	
				Art Unit	2876	
(use as many sheets as necessary)			essary)	Examiner Name		
Sheet	1	of	2	Attorney Docket Number	CEDE 2132.8	

Examiner Initials*	Cite No.1	Document Number Number-Kind Code ²		Publication Date MM-DD-YYYY		ame of Patentee or Applicant of Cited Document	Pages, Columns, Lir Where Relevant Passages or Relevant Figures Appear	
	1	2002/0185716	12	/12/2002	Aby	s et al.		
	2	2002/0187364	12	/12/2002	Heb	er et al.		_
	3	2002/0192492	12	/19/2002	Aby	s et al.		
	4	2003/0025182	02	/06/2003	Aby	s et al.		
	5	2003/0226758	12	/11/2003	Egli			
	6	2005/0067296	03	/31/2005	Line			
	7	4,504,427	03	/12/1985	Moy	/er		
	8	4,601,957	07	/22/1986	Fuji	moto et al.		
	9	4,749,626	06	/07/1988	Kad	lija et al.		
	10	4,786,324	11	/22/1988	Rie	ger		
	11	4,959,278	09	/25/1990	Shir	mauchi et al.		
-	12	5,393,573	02	/28/1995	Mad	Kay		
	13	5,675,177	10	/07/1997	Aby	s		
-	14	5,750,017	05	/12/1998	Zha	ng		
	15	5,916,696	06	/29/1999	Aby	'S		
	16	6,090,263	07	/18/2000	Aby	'S		
	17	6,136,460	10	/24/2000	Che	en et al.		_
	18	6,248,455	06	/19/2001	Ada	ms et al.		
	19	6,399,220	06	/04/2002	Aby	s		_
	20	6,452,258	09	/17/2002	Aby	s et al.		
	21	6,613,451	09	/02/2003	Asa	hara et al.		
	22	6,720,499	05	/30/2002	Bok	isa et al.		
	23	6,860,981	10	/30/2003	Sch	etty III et al.		
	24	6,982,030	05	/27/2004	Zha	ng et al.		
			FOREI	GN PATENT	DOCUM	MENTS		
Examiner Initials	Cite No.1	Foreign Patent Documer Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)		Publication Date MM-DD-YYYY		Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant	T ⁶
							Figures Appear	
		JP 59-222594		12/14/1984	Susum			
	26	DE 2129819		12/21/1972	Betsch	art		
Examin Signatu					Date Consider	ed		_

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance

and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ³Enter Office that issued the document, by the two-letter code (WIPO Standard). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁶Applicant is to place a check mark here if English Translation is attached or place an "A" here if English language abstract is attached.

PTO/SB/08A				Complete if Known		
				Application Number	10/597,374	
INFORMATION DISCLOSURE			SURE	Filing Date	07/21/2006	
STAT	STATEMENT BY APPLICANT			First Named Inventor	Chen Xu	
				Art Unit	2876	
(use as many sheets as necessary)			ecessary)	Examiner Name		
Sheet	2	of	2	Attorney Docket Number	CEDE 2132.8	

-	27	DE 10159890 07/24/2003 Linde et al.				
		OTHER ART - NON PATENT LITERATURE DOCUMENTS				
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	1.6			
	28	BURSSE et al., "Tin Whiskers: Attributes and Mitigation", Carts Europe 2002: 16th Components Symposium, pgs 221-233				
	29	OSENBACH et al., "The Effects of Board Attachment Processing on Sn Whisker Formation on Electroplated Matte-Sn on Cu Alloy Lead Frames", IPC/JEDEC Conference, March 17, 2004				
	30	WIPO Preliminary Report on Patentability of PCT/US2005/001999 dated 08/03/2006, 6 pgs				
	31	XU et al., "Whisker Prevention", April 2003, pgs 1-8				
_	32	XU et al., "Understanding Whisker Phenomenon - Driving Force for the Whisker Formation", Apex 2002, April 2002, pgs 1-6				
	33	XU et al., "Understanding Whisker Phenomenon: The Driving Force for Whisker Formation", www.circuitree.com, pgs 94-104, April 2002				
	34	VAN DER PAS et al., "Immersion Tin: The Final Answer for Lead-Free?", Printed Circuit Europe - 4th Quarter 2003, pgs 32-35				
	35	ZHANG et al., "Understanding Whisker Phenomenon Whisker Index and Tin/Copper, Tin/Nickel Interface", Apex 2002, pgs 1-11				
_	36	ZHANG et al., "Tin Whisker Growth", Apex Expo, February 25, 2004				

Examiner	Date	
Signature	Considered	

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁶ Applicant is to place a check mark here if English Translation is attached or place an "A" here if English language abstract is attached.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Chen Xu Serial No. 10/597,374 Filed July 21, 2006 Confirmation No. 9982 Art Unit 2876

For PRESERVING SOLDERABILITY AND INHIBITING WHISKER GROWTH IN TIN SURFACES OF ELECTRONIC COMPONENTS

October 26, 2006

TO THE COMMISSIONER FOR PATENTS,

SIR:

INFORMATION DISCLOSURE STATEMENT

In accordance with 37 C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 C.F.R. 1.56, applicants submit the attached PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

The references listed on the attached PTO/SB/08A have been previously submitted in parent application Serial No. 10/968,500 and, therefore, in accordance with MPEP 609, are not being provided at this time.

Respectfully submitted,

Paul I. J. Fleischut, Reg. No. 35,513

Paul Fleishet

SENNIGER POWERS

One Metropolitan Square, 16th Floor

St. Louis, Missouri 63102

(314) 231-5400

PIF/DER/sat